- State-of-the-Art BiCMOS Design Significantly Reduces I<sub>CCZ</sub>
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Designed to Facilitate Incident-Wave Switching for Line Impedances of 25  $\Omega$  or Greater
- Distributed V<sub>CC</sub> and GND Pins Minimize Noise Generated by the Simultaneous Switching of Outputs
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic and Ceramic 300-mil DIPs (JT, NT)

#### description

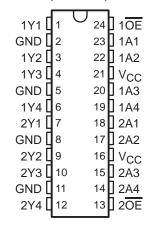
These  $25-\Omega$  octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These buffers are capable of sinking 188-mA  $I_{OL}$ , which facilitates switching 25- $\Omega$  transmission lines on the incident wave. The distributed  $V_{CC}$  and GND pins minimize switching noise for more reliable system operation.

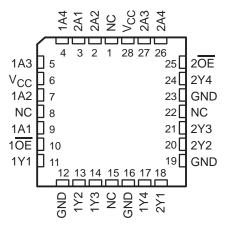
When the output-enable (1 $\overline{OE}$  and 2 $\overline{OE}$ ) inputs are low, the device transmits data from the A inputs to the Y outputs. When 1 $\overline{OE}$  and 2 $\overline{OE}$  are high, the outputs are in the high-impedance state.

The SN54BCT25244 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74BCT25244 is characterized for operation from 0°C to 70°C.

#### SN54BCT25244 . . . JT OR W PACKAGE SN74BCT25244 . . . DW OR NT PACKAGE (TOP VIEW)



# SN54BCT25244 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

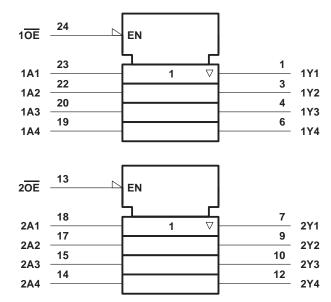
# FUNCTION TABLE (each buffer/driver)

INPU	JTS	ОИТРИТ
OE	Α	Y
L	Н	Н
L	L	L
Н	Χ	Z



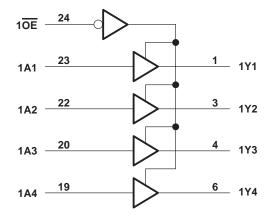
SCBS064A - JUNE 1990 - REVISED NOVEMBER 1993

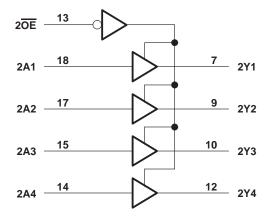
#### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)





Pin numbers shown are for the DW, JT, NT, and W packages.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	
Voltage range applied to any output in the disabled or power-off state, VO	
Voltage range applied to any output in the high state, VO	0.5 V to V <sub>CC</sub>
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–30 mA
Current into any output in the low state, IO: SN54BCT25244	250 mA
SN74BCT25244	376 mA
Operating free-air temperature range: SN54BCT25244	−55°C to 125°C
SN74BCT25244	0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

## recommended operating conditions (see Note 2)

		SN5	SN54BCT25244			SN74BCT25244			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V	
VIH	High-level input voltage	2			2			V	
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V	
ΙK	Input clamp current			-18			-18	mA	
ІОН	High-level output current			-53			-80	mA	
IOL	Low-level output current			125			188	mA	
TA	Operating free-air temperature	-55		125	0		70	°C	

NOTE 2: Unused or floating inputs must be held high or low.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEG	ET CONDITIONS	SN5	4BCT25	244	SN7	4BCT25	244	UNIT
PARAMETER	l les	TEST CONDITIONS		TYP <sup>†</sup>	MAX	MIN	TYP†	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -3 \text{ mA}$				2.7			
VOH	V <sub>CC</sub> = 4.5 V	$I_{OH} = -53 \text{ mA}$	2						V
	VCC = 4.5 V	$I_{OH} = -80 \text{ mA}$				2			
		I <sub>OL</sub> = 94 mA		0.38	0.55		0.42	0.55	
$V_{OL}$	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 125 mA			0.8				V
		I <sub>OL</sub> = 188 mA						0.7	
lį	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 5.5 V			0.1			0.1	mA
lН	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
I <sub>IL</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.5 V			-0.6			-0.6	mA
I <sub>OZH</sub>	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.7 V			50			50	μΑ
lozL	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.5 V			-50			-50	μΑ
ICCL	V <sub>CC</sub> = 5.5 V,	Outputs open		90	119		90	119	mA
ІССН	V <sub>CC</sub> = 5.5 V,	Outputs open		59	78		59	78	mA
lccz	V <sub>CC</sub> = 5.5 V,	Outputs open		7	11		7	11	mA
C <sub>i</sub>	V <sub>CC</sub> = 5 V,	V <sub>I</sub> = 2.5 V or 0.5 V		5.5			5.5		pF
Co	V <sub>CC</sub> = 5 V,	V <sub>O</sub> = 2.5 V or 0.5 V		17			17		pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (unless otherwise noted) (see Note 3)

	• •		, ,		•					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		SN54BC	Γ25244	SN74BC	Γ25244	UNIT	
	(INPOT)	(0011-01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Α Α	V	1	3.2	4.9	1	5.6	1	5.5	no
t <sub>PHL</sub>		Ť	2	4	5.6	2	6.3	2	6	ns
<sup>t</sup> PZH	OF	Y	3.2	5.6	8.5	3.2	9.7	3.2	9.3	no
t <sub>PZL</sub>	OE		3.7	6.3	9.2	3.7	10.4	3.7	10.2	ns
<sup>t</sup> PHZ	ŌĒ	Y	1.6	3.6	5.5	1.6	6.5	1.6	6.3	200
tPLZ			3.1	5.3	7.8	3.1	9.5	3.1	8.4	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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#### PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74BCT25244DW	Obsolete	Production	SOIC (DW)   24	-	-	Call TI	Call TI	0 to 70	BCT25244
SN74BCT25244DWR	Active	Production	SOIC (DW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT25244
SN74BCT25244DWR.A	Active	Production	SOIC (DW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT25244

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

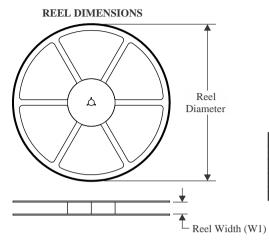
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

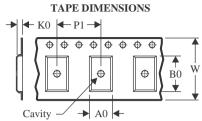
<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

## **PACKAGE MATERIALS INFORMATION**

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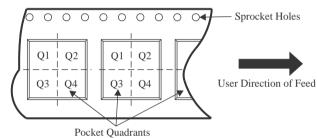
#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

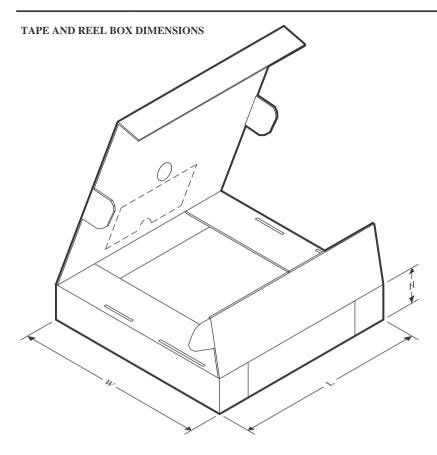


#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74BCT25244DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1

# **PACKAGE MATERIALS INFORMATION**

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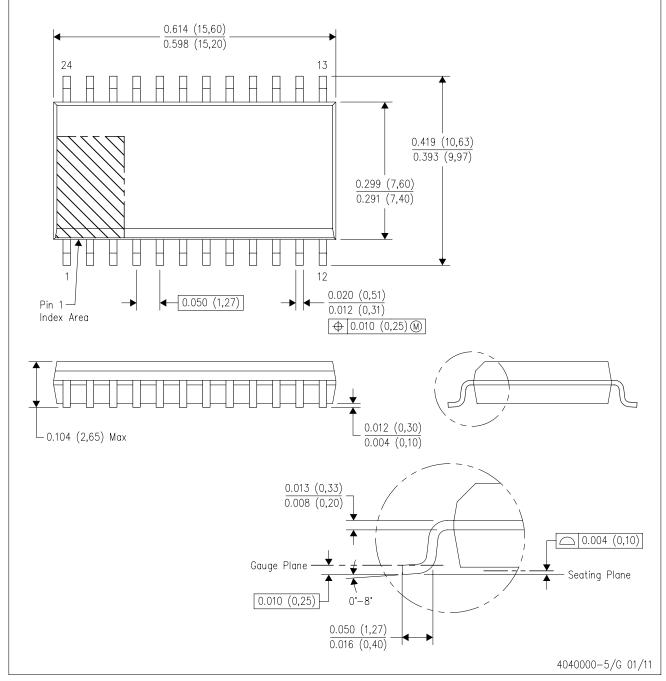


#### \*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74BCT25244DWR	SOIC	DW	24	2000	350.0	350.0	43.0	

DW (R-PDSO-G24)

## PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



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